

# **ACADEMIC REGULATIONS & COURSE STRUCTURE**

**For**

**COMPUTER AIDED DESIGN & MANUFACTURING**

*(Applicable for batches admitted from 2016-2017)*



**JAWAHARLAL NEHRU TECHNOLOGICAL UNIVERSITY: KAKINADA**  
**KAKINADA - 533 003, Andhra Pradesh, India**

## I Semester

S.No.	Subject	L	P	C
1	Industrial Robotics	4	--	3
2	Computer Aided Manufacturing	4	--	3
3	Special Manufacturing Processes	4		3
4	Geometric Modeling	4	--	3
5	<b>Elective I</b> 1. Computational Methods in Engineering 2. Mechanical Vibrations 3. Nano Technology 4. Total Quality Management	4	--	3
6	<b>Elective II</b> 1. Design for Manufacturing & Assembly 2. Mechatronics 3. Computer Aided Process Planning 4. Precision Engineering	4	--	3
7	Advanced CAD Lab	--	3	2
<b>Total Credits</b>				<b>20</b>

## II Semester

S.No.	Subject	L	P	C
1	Modeling & Simulation of Manufacturing Systems	4	--	3
2	Optimization and Reliability	4	--	3
3	Computer Graphics	4	--	3
4	Finite Element Methods	4	--	3
	<b>Elective III</b> 1. Quality Engineering in Manufacturing 2. Fracture Mechanics 3. Concurrent Engineering 4. Design and Manufacturing of MEMS and Microsystems	4	--	3
	<b>Elective IV</b> 1. Mechanics and Manufacturing Methods of Composites 2. Materials Technology 3. Intelligent Manufacturing Systems 4. Signal Analysis and Condition Monitoring	4	--	3
	Modeling & Analysis of Manufacturing Processes Lab	--	3	2
<b>Total Credits</b>				<b>20</b>

### III Semester

S. No.	Subject	L	P	Credits
1	Comprehensive Viva-Voce	--	--	2
2	Seminar – I	--	--	2
3	Project Work Part - I	--	--	16
Total Credits				20

### IV Semester

S. No.	Subject	L	P	Credits
1	Seminar – II	--	--	2
2	Project Work Part - II	--	--	18
Total Credits				20

<b>I Year I Semester</b>	<b>INDUSTRIAL ROBOTICS</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

### **UNIT - I**

**INTRODUCTION:** Automation and Robotics, Robot anatomy, robot configuration, motions joint notation scheme, work volume, robot drive systems, control systems and dynamic performance, precision of movement.

**CONTROL SYSTEM AND COMPONENTS:** basic concepts and motion controllers, control system analysis, robot actuation and feedback components, Positions sensors, velocity sensors, actuators, power transmission systems, robot joint control design.

### **UNIT - II**

**MOTION ANALYSIS AND CONTROL:** Manipulator kinematics, position representation, forward and inverse transformations, homogeneous transformations, manipulator path control, robot arm dynamics, configuration of a robot controller.

### **UNIT - III**

**END EFFECTORS:** Grippers-types, operation, mechanism, force analysis, tools as end effectors consideration in gripper selection and design. **SENSORS:** Desirable features, tactile, proximity and range sensors, uses sensors in robotics.

**MACHINE VISION:** Functions, Sensing and Digitizing-imaging devices, Lighting techniques, Analog to digital single conversion, image storage: Image processing and Analysis-image data reduction, Segmentation, feature extraction, Object recognition. Training the vision system, Robotic application.

### **UNIT - IV**

**ROBOT PROGRAMMING:** Lead through programming, Robot program as a path in space, Motion interpolation, WAIT, SIGNAL AND DELAY commands, Branching, capabilities and Limitations of lead through methods.

**ROBOT LANGUAGES:** Textual robot Languages, Generations of robot programming languages, Robot language structures, Elements and function.

### **UNIT - V**

**ROBOT CELL DESIGN AND CONTROL:** Robot cell layouts-Robot centered cell, In-line robot cell, Considerations in work design, Work and control, Inter locks, Error detection, Work cell controller.

**ROBOT APPLICATION:** Material transfer, Machine loading/unloading, Processing operation, Assembly and Inspection, Future Application.

### **TEXT BOOKS:**

1. Industrial Robotics / Groover M P /Pearson Edu.
2. Introduction to Robotic Mechanics and Control by JJ Craig, Pearson, 3rd edition.

### **REFERENCES:**

- 1 Robotics / Fu K S/ McGraw Hill.
- 2 Robotic Engineering / Richard D. Klafter, Prentice Hall
- 3 Robot Analysis and Intelligence / Asada and Slotine / Wiley Inter-Science.

- 4 Robot Dynamics & Control – Mark W. Spong and M. Vidyasagar / John Wiley
- 5 Introduction to Robotics by SK Saha, The McGraw Hill Company, 6<sup>th</sup>, 2012
- 6 Robotics and Control / Mittal R K & Nagrath I J / TMH

<b>I Year I Semester</b>	<b>COMPUTER AIDED MANUFACTURING</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

#### **UNIT - I**

**COMPUTER AIDED PROGRAMMING:** General information, APT programming, Examples Apt programming problems (2D machining only). NC programming on CAD/CAM systems, the design and implementation of post processors .Introduction to CAD/CAM software, Automatic Tool Path generation.

#### **UNIT - II**

**TOOLING FOR CNC MACHINES:** Interchangeable tooling system, preset and qualified toois, coolant fed tooling system, modular fixturing, quick change tooling system, automatic head changers. DNC Systems and Adaptive Control: Introduction, type of DNC systems, advantages arid disadvantages of DNC, adaptive control with optimization, Adaptive control with constrains, Adaptive control of machining processes like turning, grinding.

#### **UNIT - III**

**POST PROCESSORS FOR CNC:** Introduction to Post Processors: The necessity of a Post Processor, the general structure of a Post Processor, the functions of a Post Processor, DAPP — based- Post Processor: Communication channels and major variables in the DAPP — based Post Processor, th creation of a DAPP — Based Post Processor.

#### **UNIT - IV**

**MICRO CONTROLLERS:** Introduction, Hardware components, I/O pins, ports, external memory:, counters, timers and serial data I/O interrupts. Selection of Micro Controllers Embedded Controllers, Applications and Programming of Micro Controllers. Programmable Logic Controllers (PLC' s): Introduction, Hardware components of PLC, System, basic structure, principle of operations, Programming mnemonics timers, Internal relays and counters, Applications of PLC's in CNC Machines.

#### **UNIT - V**

**COMPUTER AIDED PROCESS PLANNING:** Hybrid CAAP System, Computer Aided Inspection and quality control, Coordinate Measuring Machine, Limitations of CMM, Computer Aided Testing, Optical Inspection Methods, Artificial Intelligence and expert system: Artificial Neural Networks, Artificial Intelligence in CAD, Experts systems and its structures.

#### **TEXT BOOKS:**

1. Computer Control of Manufacturing Systems / Yoram Koren / Mc Graw Hill. 1983.
2. CAD/CAM Principles and Applications, P.N.Rao, TMH

#### **REFERENCES:**

1. Computer Aided Design Manufacturing – K. Lalit Narayan, K. Mallikarjuna Rao and M.M.M. Sarcar, PHI, 2008.
2. CAD / CAM Theory and Practice,/ Ibrahim Zeid,TMH
3. CAD / CAM / CIM, Radhakrishnan and Subramanian, New Age
4. Principles of Computer Aided Design and Manufacturing, Farid Amirouche, Pearson
5. Computer Numerical Control Concepts and programming, Warren S Seames, Thomson.

<b>I Year I Semester</b>	<b>SPECIAL MANUFACTURING PROCESS</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

#### **UNIT-I**

**SURFACE TREATMENT:** Scope, Cleaners, Methods of cleaning, Surface coating types, and ceramic and organic methods of coating, economics of coating. Electro forming, Chemical vapor deposition, thermal spraying, Ion implantation, diffusion coating, Diamond coating and cladding.

#### **UNIT- II**

**PROCESSING OF CERAMICS:** Applications, characteristics, classification .Processing of particulate ceramics, Powder preparations, consolidation, Drying, sintering, Hot compaction, Area of application, finishing of ceramics. Processing of Composites: Composite Layers, Particulate and fiber reinforced composites, Elastomers, Reinforced plastics, MMC, CMC, Polymer matrix composites.

#### **UNIT- III**

##### **FABRICATION OF MICROELECTRONIC DEVICES:**

Crystal growth and wafer preparation, Film Deposition oxidation, lithography, bonding and packaging, reliability and yield, Printed Circuit boards, computer aided design in micro electronics, surface mount technology, Integrated circuit economics.

#### **UNIT - IV**

**ADVANCED MACHINING PROCESSES:** EDM, WireEDM, ECM, LBM, EBM, AJM, WJM – Principle, working, limitations and applications.

#### **UNIT -V**

**RAPID PROTOTYPING:** Working Principles, Methods, Stereo Lithography, Laser Sintering, Fused Deposition Method, Applications and Limitations, Rapid tooling, Techniques of rapid manufacturing

#### **TEXT BOOKS:**

1. Manufacturing Engineering and Technology / Kalpakijian / Adisson Wesley, 1995.
2. Process and Materials of Manufacturing / R. A. Lindburg / 1th edition, PHI 1990.

#### **REFERENCES:**

- 1 Microelectronic packaging handbook / Rao. R. Thummala and Eugene, J. Rymaszewski / Van Nostrand Renihold,
- 2 MEMS & Micro Systems Design and manufacture / Tai — Run Hsu / TMGH
- 3 Advanced Machining Processes / V.K.Jain / Allied Publications.
4. Introduction to Manufacturing Processes / John A Schey / Mc Graw Hill.

<b>I Year I Semester</b>	<b>GEOMETRIC MODELING</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

### **Unit - I**

**Cubic splines –I** Definition, Explicit and implicit equations, parametric equations, Algebraic and geometric form of cubic spline, Hermite cubic spline, tangent vectors, parametric space of a curve, blending functions.

### **Unit - II**

#### **Cubic Splines-II:**

four point form, reparametrization, truncating and subdividing of curves. Graphic construction and interpretation, composite pc curves.

**Bezier Curves:** Bernstein basis, equations of Bezier curves, properties, derivatives.

### **Unit - III**

**B-Spline Curves:** B-Spline basis, equations, knot vectors, properties, and derivatives.

### **Unit – IV**

**Surfaces:** Bicubic surfaces, Coon's surfaces, Bezier surfaces, B-Spline surfaces, surfaces of revolutions, Sweep surfaces, ruled surfaces, tabulated cylinder, bilinear surfaces, Gaussian curvature.

### **Unit – V**

**Solids:** Tricubic solid, Algebraic and geometric form.

**Solid modeling concepts:** Wire frames, Boundary representation, Half space modeling, spatial cell, cell decomposition, classification problem.

### **TEXT BOOKS:**

1. Elements of Computer Graphics by Roger & Adams Tata McGraw Hill.
2. Geometric Modeling by Micheal E. Mortenson, McGraw Hill Publishers

### **REFERENCES:**

1. Computer Aided Design and Manufacturing, K.Lalit Narayan, K.Mallikarjuna Rao, MMM Sarcar, PHI Publishers

<b>I Year I Semester</b>		<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

**COMPUTATIONAL METHODS IN ENGINEERING  
(ELECTIVE I)**

**Unit – I**

**Introduction to numerical methods applied to engineering problems:** Examples, solving sets of equations – Matrix notation – Determinants and inversion – Iterative methods – Relaxation methods – System of non-linear equations. Least square approximation fitting of non-linear curves by least squares – regression analysis- multiple linear regression, non linear regression - computer programs.

**Unit – II**

**Boundry value problems and charecteristic value problems:** Shooting method – Solution through a set of equations – Derivative boundary conditions – Rayleigh – Ritz method – Characteristic value problems.

**Unit – III**

**Transformation Techniques:** Continuous fourier series, frequency and time domains, laplace transform, fourier integral and transform, discrete fourier transform (DFT), Fast fourier transform (FFT).

**Unit – IV**

**Numerical solutions of partial differential equations:** Laplace's equations – Representations as a difference equation – Iterative methods for Laplace's equations – poisson equation – Examples – Derivative boundary conditions – Irregular and non – rectangular grids – Matrix patterns, sparseness – ADI method – Finite element method.

**Unit – V**

**Partial differential equations:** Explicit method – Crank-Nickelson method – Derivative boundary condition – Stability and convergence criteria. Solving wave equation by finite differences-stability of numerical method –method of characteristics-wave equation in two space dimensions-computer programs.

**TEXT BOOKS:**

1. Steven C.Chapra, Raymond P.Canale “Numerical Methods for Engineers” Tata Mc-Graw Hill
- 2.Curtis F.Gerald, Partick.O.Wheatly,”Applied numerical analysis”Addison-Wesley,1989
- 3.Douglas J.Faires,Riched Burden”Numerical methods”, Brooks/Cole publishing company,1998.Second edition.

**REFERENCES:**

- 1.Ward Cheney and David Kincaid “Numerical mathematics and computing” Brooks/Cole publishing company1999, Fourth edition.
- 2.Riley K.F,. M.P.Hobson and Bence S.J,”Mathematical methods for physics and engineering”, Cambridge University press,1999.
3. Kreysis, Advanced Mathematics

# MECHANICAL VIBRATIONS

## (ELECTIVE - I)

### Unit I

**Single degree of Freedom systems:** Undamped and damped free vibrations: forced vibrations ; coulomb damping; Response to harmonic excitation; rotating unbalance and support excitation, Vibration isolation and transmissibility, Vibrometers, velocity meters & accelerometers.

### Unit II

Response to Non Periodic Excitations: unit Impulse, unit step and unit Ramp functions; response to arbitrary excitations, The Convolution Integral; shock spectrum; System response by the Laplace Transformation method.

### Unit III

**Multi degree freedom systems:** Principal modes – undamped and damped free and forced vibrations ; undamped vibration absorbers, Matrix formulation, stiffness and flexibility influence coefficients; Eigen value problem; normal modes and their properties; Free and forced vibration by Modal analysis; Method of matrix inversion; Torsional vibrations of multi – rotor systems and geared systems; Discrete-Time systems.

### Unit IV

**Numerical Methods:** Rayleigh's, Stodola's, Matrix iteration, Rayleigh-Ritz Method and Holzer's methods

### Unit V

**Application of concepts:** Free vibration of strings – longitudinal oscillations of bars-transverse vibrations of beams- Torsional vibrations of shafts. Critical speeds without and with damping, secondary critical speed.

### Text books:

1. Elements of Vibration Analysis by Meirovitch.
2. Mechanical Vibrations by G.K. Groover.

### References:

1. Vibrations by W.T. Thomson
2. Mechanical Vibrations – Schaum series.
3. Vibration problems in Engineering by S.P. Timoshenko.
4. Mechanical Vibrations – V.Ram Murthy.

# **NANO TECHNOLOGY**

## **(ELECTIVE - I)**

### **UNIT-I**

Introduction, Size and shape dependence of material properties at the nanoscale, scaling relations, can nanorobots walk and nanoplanes fly, Nano scale elements in conventional technologies, Mechanics at nanoscale Enhancement of mechanical properties with decreasing size, Nanoelectromechanical systems, nano machines, Nano fluidics, filtration, sorting, Molecular motors, Application of Nano Technology.

### **UNIT-II**

Nano material Synthesis Techniques: Top-down and bottom-up nanofabrication, Synthesis of nano composites, The Intel-IBM approach to nanotechnology: lithography, etching, ion implantation, thin film deposition, nano coatings and nano indentation, Electron beam lithography, Soft lithography: nanoimprinting and microcontact printing, Solution/plasma-phase nanofabrication, sol-gel methods, template techniques.

### **UNIT-III**

Imaging/characterization of nanostructures General considerations for imaging, Scanning probe techniques: XRD, SEM, TEM, AFM and NSOM.

### **UNIT-IV**

Metal and semiconductor nanoparticles Synthesis, stability, control of size, Optical and electronic properties, Ultra-sensitive imaging and detection with nano particles, bioengineering applications, Catalysis. Semiconductor and metal nanowires Vapor/liquid/solid growth and other synthesis techniques, Nanowire transistors and sensors.

### **UNIT-V**

Carbon nanotubes

Structure and synthesis, Electronic, vibrational, and mechanical properties, How can C nanotubes enable faster computers, brighter TV screens, and stronger mechanical reinforcement?

### **TEXT BOOKS:**

1. Nanoscale Science and Technology by Kelsall, Hamley, and Geoghegan, Wiley (2005)
2. Introduction to Nanoscale Science and Technology by Di Ventra, Evoy, and Heflin, Kluwer Academic Publishers (2004).

### **REFERENCES:**

1. Introduction to Nanotechnology by Poole and Owens, Wiley (2003)
2. Nanochemistry: A Chemical Approach to Nanomaterials, Ozin and Arsenault, RSC Publishing (2006).

## **TOTAL QUALITY MANAGEMENT (ELECTIVE - I)**

### **UNIT – I:**

**INTRODUCTION:** The concept of TQM, Quality and Business performance, attitude and involvement of top management, communication, culture and management systems. Management of Process Quality: Definition of quality, Quality Control, a brief history, Product Inspection vs, Process Control, Statistical Quality Control, Control Charts and Acceptance Sampling.

### **UNIT – II:**

**CUSTOMER FOCUS AND SATISFACTION:** The importance of customer satisfaction and loyalty- Crating satisfied customers, Understanding the customer needs, Process Vs. Customer, internal customer conflict, quality focus, Customer Satisfaction, role of Marketing and Sales, Buyer – Supplier relationships. Bench Marketing: Evolution of Bench Marketing, meaning of Bench marketing, benefits of bench marketing, the bench marketing process, pitfalls of bench marketing.

### **UNIT – III:**

**ORGANIZING FOR TQM:** The systems approach, Organizing for quality implementation, making the transition from a traditional to a TQM organizing, Quality Circles. Productivity, Quality and Reengineering: The leverage of Productivity and Quality, Management systems Vs. Technology, Measuring Productivity, Improving Productivity Re-engineering.

### **UNIT – IV:**

**THE COST OF QUALITY:** Definition of the Cost of Quality, Quality Costs, Measuring Quality Costs, use of Quality Cost Information, Accounting Systems and Quality Management.

### **UNIT – V:**

**ISO9000:** Universal Standards of Quality: ISO around the world, The ISO9000 ANSI/ASQCQ-90. Series Standards, benefits of ISO9000 certification, the third party audit, Documentation ISO9000 and services, the cost of certification implementing the system.

### **TEXT BOOKS:**

1. Total Quality Management / Joel E.Ross/Taylor and Franscis Limited
2. Total Quality Management/P.N.Mukherjee/PHI

### **REFERENCES:**

- 1 Beyond TQM / Robert L.Flood
- 2 Statistical Quality Control / E.L. Grant / McGraw Hill.
- 3 Total Quality Management- A Practical Approach/H. Lal
- 4 Quality Management/Kanishka Bedi/Oxford University Press/2011
- 5 Total Engineering Quality Management/Sunil Sharma/Macmillan

<b>I Year I Semester</b>		<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

**DESIGN FOR MANUFACTURING & ASSEMBLY  
(ELECTIVE - II)**

**UNIT - I**

Introduction to DFM, DFMA: How Does DFMA Work? Reasons for Not Implementing DFMA, What Are the Advantages of Applying DFMA During Product Design?, Typical DFMA Case Studies, Overall Impact of DFMA on Industry.

Design for Manual Assembly: General Design Guidelines for Manual Assembly, Development of the Systematic DFA Methodology, Assembly Efficiency, Effect of Part Symmetry, Thickness, Weight on Handling Time, Effects of Combinations of Factors, Application of the DFA Methodology.

**UNIT - II**

Machining processes: Overview of various machining processes-general design rules for machining-dimensional tolerance and surface roughness-Design for machining – ease – redesigning of components for machining ease with suitable examples. General design recommendations for machined parts.

**UNIT - III**

Metal casting: Appraisal of various casting processes, selection of casting process,-general design considerations for casting-casting tolerance-use of solidification, simulation in casting design-product design rules for sand casting.

**Extrusion & Sheet metal work:** Design guide lines extruded sections-design principles for punching, blanking, bending, deep drawing-Keeler Goodman forging line diagram – component design for blanking.

**UNIT - IV**

Metal joining: Appraisal of various welding processes, factors in design of weldments – general design guidelines-pre and post treatment of welds-effects of thermal stresses in weld joints-design of brazed joints.

Forging: Design factors for forging – closed die forging design – parting lines of dies – drop forging die design – general design recommendations.

**UNIT – V**

Design for Assembly Automation: Fundamentals of automated assembly systems, System configurations, parts delivery system at workstations, various escapement and placement devices used in automated assembly systems, Quantitative analysis of Assembly systems, Multi station assembly systems, single station assembly lines.

**TEXT BOOKS:**

1. Design for manufacture, John cobert, Adisson Wesley. 1995
2. Design for Manufacture by Boothroyd,
3. Design for manufacture, James Bralla

**REFERENCE:**

1. ASM Hand book Vol.20

## **MECHATRONICS (ELECTIVE II)**

### **UNIT-I**

Mechatronics systems, elements, levels of mechatronics system, Mechatronics design process, system, measurement systems, control systems, microprocessor-based controllers, advantages and disadvantages of mechatronics systems. Sensors and transducers, types, displacement, position, proximity, velocity, motion , force, acceleration, torque, fluid pressure, liquid flow, liquid level, temperature and light sensors.

### **UNIT-II**

Solid state electronic devices, PN junction diode, BJT, FET, DIA and TRIAC. Analog signal conditioning, amplifiers, filtering. Introduction to MEMS & typical applications.

### **UNIT-III**

Hydraulic and pneumatic actuating systems, Fluid systems, Hydraulic and pneumatic systems, components, control valves, electro-pneumatic, hydro-pneumatic, electro-hydraulic servo systems:

Mechanical actuating systems and electrical actuating systems.

### **UNIT-IV**

Digital electronics and systems, digital logic control, micro processors and micro controllers, programming, process controllers, programmable logic controllers, PLCs versus computers, application of PLCs for control.

### **UNIT-V**

System and interfacing and data acquisition, DAQS , SCADA, A to D and D to A conversions; Dynamic models and analogies, System response. Design of mechatronics systems & future trends.

### **TEXT BOOKS:**

1. MECHATRONICS Integrated Mechanical Electronics Systems/KP Ramachandran & GK Vijaya Raghavan/WILEY India Edition/2008
2. Mechatronics Electronics Control Systems in Mechanical and Electrical Engineering by W Bolton, Pearson Education Press, 3rd edition, 2005.

### **REFERENCES:**

- 1 Mechatronics Source Book by Newton C Braga, Thomson Publications, Chennai.
- 2 Mechatronics – N. Shanmugam / Anuradha Agencies Publishers.
- 3 Mechatronics System Design / Devdas shetty/Richard/Thomson.
- 4 Mechatronics/M.D.Singh/J.G.Joshi/PHI.
- 5 Mechatronics – Electronic Control Systems in Mechanical and Electrical Engg. 4<sup>th</sup> Edition, Pearson, 2012 W. Bolton
- 6 Mechatronics – Principles and Application Godfrey C. Onwubolu, Wlsevier, 2006 Indian print

## **COMPUTER AIDED PROCESS PLANNING (ELECTIVE - II)**

### **Unit - I**

**Introduction to CAPP:** Information requirement for process planning system, Role of process planning, advantages of conventional process planning over CAPP, Structure of Automated process planning system, feature recognition, methods.

### **Unit - II**

**Generative CAPP system:** Importance, principle of Generative CAPP system, automation of logical decisions, Knowledge based systems, Inference Engine, implementation, benefits.

**Retrieval CAPP system:** Significance, group technology, structure, relative advantages, implementation, and applications.

### **Unit – III**

**Selection of manufacturing sequence:** Significance, alternative manufacturing processes, reduction of total set-up cost for a particular sequence, quantitative methods for optimal selection, examples.

**Determination of machining parameters:** reasons for optimal selection of machining parameters, effect of parameters on production rate, cost and surface quality, different approaches, advantages of mathematical approach over conventional approach, solving optimization models of machining processes.

### **Unit –IV**

**Determination of manufacturing tolerances:** design tolerances, manufacturing tolerances, methods of tolerance allocation, sequential approach, integration of design and manufacturing tolerances, advantages of integrated approach over sequential approach.

### **Unit –V**

**Generation of tool path:** Simulation of machining processes, NC tool path generation, graphical implementation, determination of optimal index positions for executing fixed sequence, quantitative methods.

**Implementation techniques for CAPP:** MIPLAN system, Computer programming languages for CAPP, criteria for selecting a CAPP system and benefits of CAPP. Computer integrated planning systems, and Capacity planning system.

### **TEXT BOOK:**

1. Computer Aided Process Planning – Joseph Tulkoff, SME Publications
2. Computer Aided Process Planning – Hsu-Pin Wang, Jian-Kang Li, Elsevier

### **REFERENCES:**

- 1.Automation , Production systems and Computer Integrated Manufacturing System – Mikell P.Groover
- 2.Computer Aided Design and Manufacturing – Dr.Sadhu Singh.
- 3.Computer Aided Engineering – David Bedworth

## **PRECISION ENGINEERING**

### **(ELECTIVE - II)**

#### **UNIT I:**

**CONCEPTS OF ACCURACY:** Introduction – Concept of Accuracy of Machine Tools – Spindle and Displacement Accuracies – Accuracy of numerical Control Systems – Errors due to Numerical Interpolation Displacement Measurement System and Velocity lags.

#### **UNIT II:**

**GEOMETRIC DIMENSIONING AND TOLERANCING:** Tolerance Zone Conversions – Surfaces, Features, Features of Size, Datum Features – Datum Oddly Configured and Curved Surfaces as Datum Features, Equalizing Datums – Datum Feature of Representation – Form controls, Orientation Controls – Logical Approach to Tolerancing.

#### **UNIT III:**

**DATUM SYSTEMS:** Design of freedom, Grouped Datum Systems – different types, two and three mutually perpendicular grouped datum planes; Grouped datum system with spigot and recess, pin and hole; Grouped Datum system with spigot and recess pair and tongue – slot pair – Computation of Translational and rotational accuracy, Geometric analysis and application.

#### **UNIT IV:**

**TOLERANCE ANALYSIS:** Process Capability, Mean, Variance, Skewness, Kurtosis, Process Capability Metrics, Cp, Cpk, Cost aspects, Feature Tolerances, Geometric Tolerances. Surface finish, Review of relationship between attainable tolerance grades and different machining process, Cumulative effect of tolerances sure fit law, normal law and truncated normal law.

#### **UNIT V:**

**TOLERANCE CHARTING TECHNIQUES:** Operation Sequence for typical shaft type of components, Preparation of Process drawings for different operations, Tolerance worksheets and centrally analysis, Examples, Design features to facilitate machining; Datum Features – functional and manufacturing Components design – Machining Considerations, Redesign for manufactured, Examples.

#### **TEXT BOOKS:**

2. Precision Engineering in Manufacturing/Murthy R.L./New Age International (P) limited, 1996.
3. Geometric Dimensioning and Tolerancing / James D. Meadows / Marcel Dekker inc. 1995.

#### **REFERENCES:**

- 1 Engineering Design – A systematic Approach / Matousek / Blackie & Son Ltd., London
- 2 Precision Engineering/VC Venkatesh & S Izman/TMH

<b>I Year I Semester</b>	<b>ADVANCED CAD LAB</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>0</b>	<b>3</b>	<b>2</b>

**Students shall carry out the modeling and FE analysis of the following to predict deflection and stress distributions :**

1. Trussess – 2D and 3D
- 2.Beams
3. Plate with Plane stress condition
4. Plate with Plane strain condition
5. Cylinders – Axi-symmetric condition
6. Natural frequencies of Beam

<b>I Year II Semester</b>	<b>MODELLING AND SIMULATION OF MANUFACTURING SYSTEMS</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

### **Unit-I**

**Introduction to System and simulation:** Concept of system and elements of system, Discrete and continuous system, Models of system and Principles of modeling and simulation, Monte carlo simulation, Types of simulation, Steps in simulation model, Advantages, limitations and applications of simulation, Applications of simulation in manufacturing system

### **Unit-II**

**Review of statistics and probability:** Types of discrete and continuous probability distributions such as Geometric, Poisson, Uniform, Geometric distribution with examples, Normal, Exponential distribution with examples.

### **Unit-III**

**Random numbers:** Need for RNs, Technique for Random number generation such as Mid product method, Mid square method, and Linear congruential method with examples

Test for Random numbers: Uniformity - Chi square test or Kolmogorov Smirnov test, Independency- Auto correlation test

Random Variate generation: Technique for Random variate generation such as Inverse transforms technique or Rejection method

### **Unit-IV**

**Analysis of simulation data:** Input data analysis, Verification and validation of simulation models, Output data analysis

Simulation languages: History of simulation languages, Comparison and selection of simulation languages

Design and evaluation of simulation experiments: Development and analysis of simulation models using simulation language with different manufacturing systems

### **Unit-V**

**Queueing models:** An introduction, M/M/1 and M/M/m Models with examples, Open Queueing and Closed queueing network with examples

**Markov chain models and others:** Discrete time markov chain with examples, Continues time markov chain with examples, stochastic process in manufacturing, Game theory

### **TEXT BOOKS:**

1. J.Banks, J.S. Carson, B. L. Nelson and D.M. Nicol, "Discrete Event System Simulation", PHI, New Delhi, 2009.
2. A.M. Law and W.D.Kelton, "Simulation Modeling and Analysis", Tata McGraw Hill Ltd, New Delhi, 2008.
3. N. Viswanadham and Y. Narahari, "Performance Modeling of Automated Manufacturing Systems", PHI, New Delhi, 2007

<b>I Year II Semester</b>	<b>OPTIMIZATION AND RELIABILITY</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

### **UNIT - I**

**CLASSICAL OPTIMIZATION TECHNIQUES:** Single variable optimization with and without constraints, multi – variable optimization without constraints, multi – variable optimization with constraints – method of Lagrange multipliers, Kuhn-Tucker conditions, merits and demerits of classical optimization techniques.

### **UNIT - II**

**NUMERICAL METHODS FOR OPTIMIZATION:** Nelder Mead's Simplex search method, Gradient of a function, Steepest descent method, Newton's method, Pattern search methods, conjugate method, types of penalty methods for handling constraints, advantages of numerical methods.

### **UNIT - III**

**GENETIC ALGORITHM (GA) :** Differences and similarities between conventional and evolutionary algorithms, working principle, reproduction, crossover, mutation, termination criteria, different reproduction and crossover operators, GA for constrained optimization, drawbacks of GA,

**GENETIC PROGRAMMING (GP):** Principles of genetic programming, terminal sets, functional sets, differences between GA & GP, random population generation, solving differential equations using GP.

**MULTI-OBJECTIVE GA:** Pareto's analysis, Non-dominated front, multi – objective GA, Non-dominated sorted GA, convergence criterion, applications of multi-objective problems .

### **UNIT – IV**

**APPLICATIONS OF OPTIMIZATION IN DESIGN AND MANUFACTURING SYSTEMS:** Some typical applications like optimization of path synthesis of a four-bar mechanism, minimization of weight of a cantilever beam, optimization of springs and gears, general optimization model of a machining process, optimization of arc welding parameters, and general procedure in optimizing machining operations sequence.

### **UNIT V**

**RELIABILITY:** Concepts of Engineering Statistics, risk and reliability, probabilistic approach to design, reliability theory, design for reliability, numerical problems, hazard analysis.

### **TEXT BOOKS:**

1. Optimization for Engineering Design – Kalyanmoy Deb, PHI Publishers
2. Engineering Optimization – S.S.Rao, New Age Publishers
3. Reliability Engineering by L.S.Srinath
4. Multi objective genetic algorithm by Kalyanmoy Deb, PHI Publishers.

### **REFERENCES:**

1. Genetic algorithms in Search, Optimization, and Machine learning – D.E.Goldberg, Addison-Wesley Publishers
2. Multi objective Genetic algorithms - Kalyanmoy Deb, PHI Publishers
3. Optimal design – Jasbir Arora, Mc Graw Hill (International) Publishers

4. An Introduction to Reliability and Maintainability Engineering by CE Ebeling, Waveland Printers Inc., 2009
5. Reliability Theory and Practice by I Bazovsky, Dover Publications, 2013

<b>I Year II Semester</b>	<b>COMPUTER GRAPHICS</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

### **Unit - I**

**Raster scan graphics:** Raster scan and random scan architecture, Line drawing algorithms – DDA & Bresenham algorithms, circle generation, general function rasterization, displaying lines, characters and polygons.

**Filling algorithms:** polygon filling, edge fill algorithm, seed fill algorithm, fundamentals of antialiasing and half toning.

### **Unit - II**

**Line CLIPPING:** Simple visibility algorithm, Cohen-Sutherland subdivision line clipping algorithm, midpoint sub division algorithm.

**Polygon clipping:** polygon clipping, reentrant polygon clipping – Sutherland – Hodgeman algorithm, character clipping, 3D- clipping.

### **Unit - III**

**Rendering:** Hidden line removal algorithms, surface removal algorithms, painters, Warnock, Z-buffer algorithm.

**Shading algorithms:** Constant intensity algorithm, Phong's shading algorithm, gourand shading algorithm, Comparison of shading algorithms.

### **Unit - IV**

**Computer Animation:** Design of animation sequence, general computer animation functions, raster animation, computer animation language, key frame system, motion specification.

### **Unit – V**

**Introduction to Multimedia:** Introduction, multimedia- systems, technology, architecture, trade-offs, contents, PC, Applications, data compressions, authoring system.

**Multimedia Authoring Tools:** Introduction, Types of authoring tools, Package based- in card authoring tools, Icon based authoring tools, Time based and presentation tools, object oriented authoring tools, author ware professional for windows (APW).

### **TEXT BOOKS:**

- 1.Procedural elements for computer graphics-D.F.Rogers, Tata McGraw-Hill.
- 2.Computer Graphics-Donald Hearn & M.P. Bakers.
- 3.Computer graphics-Harrington.

<b>I Year II Semester</b>	<b>FINITE ELEMENT METHODS</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

#### **UNIT - I**

**Formulation Techniques:** Methodology, Engineering problems and governing differential equations, finite elements., Variational methods-potential energy method, Raleigh Ritz method, strong and weak forms, Galerkin and weighted residual methods, calculus of variations, Essential and natural boundary conditions.

#### **UNIT – II**

**One-dimensional elements:** Bar, trusses, beams and frames, displacements, stresses and temperature effects.

#### **UNIT – III**

**Two dimensional problems:** CST, LST, four noded and eight noded rectangular elements, Lagrange basis for triangles and rectangles, serendipity interpolation functions. Axisymmetric Problems: Axisymmetric formulations, Element matrices, boundary conditions. Heat Transfer problems: Conduction and convection, examples: - two-dimensional fin.

#### **UNIT – IV**

**Isoparametric formulation:** Concepts, sub parametric, super parametric elements, numerical integration, Requirements for convergence, h-refinement and p-refinement, complete and incomplete interpolation functions, pascal's triangle, Patch test.

#### **UNIT – V**

Finite elements in Structural Analysis: Static and dynamic analysis, eigen value problems, and their solution methods, case studies using commercial finite element packages.

#### **TEXT BOOK:**

1. Finite element methods by Chandrupatla & Belagundu.

#### **REFERENCES:**

1. J.N. Reddy, Finite element method in Heat transfer and fluid dynamics, CRC press, 1994
2. Zienkiwicz O.C. & R. L. Taylor, Finite Element Method, McGraw-Hill, 1983.
3. K. J. Bathe, Finite element procedures, Prentice-Hall, 1996

<b>I Year II Semester</b>		<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

**QUALITY ENGINEERING IN MANUFACTURING  
(ELECTIVE III)**

**UNIT - I**

**QUALITY VALUE AND ENGINEERING:** An overall quality system, quality engineering in production design, quality engineering in design of production processes. Loss Function and Quality Level: Derivation and use of quadratic loss function, economic consequences of tightening tolerances as a means to improve quality, evaluations and types tolerances.(N-type,S-type and L-type)

**UNIT II:**

**TOLERANCE DESIGN AND TOLERANCING:** Functional limits, tolerance design for N-type. L-type and S-type characteristics, tolerance allocation for multiple components. Parameter and Tolerance Design: Introduction to parameter design, signal to noise ratios, Parameter design strategy, some of the case studies on parameter and tolerance designs.

**UNIT – III**

**ANALYSIS OF VARIANCE (ANOVA):** Introduction to ANOVA, Need for ANOVA, NO-way ANOVA, One-way ANOVA, Two-way ANOVA, Critique of F-test, ANOVA for four level factors, multiple level factors.

**UNIT - IV**

**ORTHOGONAL ARRAYS:** Typical test strategies, better test strategies, efficient test strategies, steps in designing, conducting and analyzing an experiment. Interpolation of Experimental Results: Interpretation methods, percent contributor, estimating the mean.

**UNIT - V**

**SIX SIGMA AND THE TECHNICAL SYSTEM:** Six sigma DMAIC methodology, tools for process improvement, six sigma in services and small organizations, statistical foundations, statistical methodology.

**TEXT BOOK:**

1. Taguchi Techniques for Quality Engineering / Phillip J. Ross / McGraw Hill/ Intl. II Edition, 1995.

**REFERENCES:**

1. Quality Engineering in Production systems by G. Taguchi, A. Elsayed et al, McGraw Hill Intl. Pub 1989.
2. Taguchi Methods explained: Practical steps to Robust Design / Papan P. Bagchi / Prentice Hall Pvt. Ltd., New Delhi.

## **FRACTURE MECHANICS (ELECTIVE - III)**

### **UNIT-I**

**Introduction:** Prediction of mechanical failure. Macroscopic failure modes; brittle and ductile behaviour. Fracture in brittle and ductile materials – characteristics of fracture surfaces; inter-granular and intra-granular failure, cleavage and micro-ductility, growth of fatigue cracks, The ductile/brittle fracture transition temperature for notched and unnotched components. Fracture at elevated temperature.

### **UNIT-II**

**Griffiths analysis:** Concept of energy release rate,  $G$ , and fracture energy,  $R$ . Modification for ductile materials, loading conditions. Concept of  $R$  curves.

**Linear Elastic Fracture Mechanics, (LEFM).** Three loading modes and the state of stress ahead of the crack tip, stress concentration factor, stress intensity factor and the material parameter the critical stress intensity factor, crack tip plasticity, effect of thickness on fracture toughness.

### **UNIT-III**

**Elastic-Plastic Fracture Mechanics; (EPFM)** The definition of alternative failure prediction parameters, Crack Tip Opening Displacement, and the  $J$  integral. Measurement of parameters and examples of use.

### **UNIT-IV**

**Fatigue:** definition of terms used to describe fatigue cycles, High Cycle Fatigue, Low Cycle Fatigue, mean stress  $R$  ratio, strain and load control.  $S$ - $N$  curves. Goodmans rule and Miners rule. Micro-mechanisms of fatigue damage, fatigue limits and initiation and propagation control, leading to a consideration of factors enhancing fatigue resistance. Total life and damage tolerant approaches to life prediction.

### **UNIT-V**

**Creep deformation:** the evolution of creep damage, primary, secondary and tertiary creep. Micro-mechanisms of creep in materials and the role of diffusion. Ashby creep deformation maps. Stress dependence of creep – power law dependence. Comparison of creep performance under different conditions – extrapolation and the use of Larson-Miller parameters. Creep-fatigue interactions. Examples.

### **TEXT BOOKS:**

1. T.L. Anderson, Fracture Mechanics Fundamentals and Applications, 2nd Ed. CRC press, (1995)
2. J.F. Knott, Fundamentals of Fracture Mechanics, Butterworths (1973)
3. G. E. Dieter, Mechanical Metallurgy, McGraw Hill, (1988)
4. S. Suresh, Fatigue of Materials, Cambridge University Press, (1998)

### **REFERENCES:**

1. B. Lawn, Fracture of Brittle Solids, Cambridge Solid State Science Series 2nd ed 1993.
2. J.F. Knott, P Withey, Worked examples in Fracture Mechanics, Institute of Materials.
3. H.L. Ewald and R.J.H. Wanhill Fracture Mechanics, Edward Arnold, (1984).
4. L.B. Freund and S. Suresh, Thin Film Materials Cambridge University Press, (2003).
9. D.C. Stouffer and L.T. Dame, Inelastic Deformation of Metals, Wiley (1996)

## **CONCURRENT ENGINEERING (ELECTIVE - III)**

### **UNIT I:**

#### **INTRODUCTION,**

Extensive definition of CE - CE design methodologies - Organizing for CE - CE tool box collaborative product development

#### **USE OF INFORMATION TECHNOLOGY**

IT support - Solid modeling - Product data management - Collaborative product commerce - Artificial Intelligence - Expert systems - Software hardware co-design.

### **UNIT II:**

#### **DESIGN STAGE**

Life-cycle design of products - opportunity for manufacturing enterprises - modality of Concurrent Engineering Design –

Automated analysis idealization control - Concurrent engineering in optimal structural design - Real time constraints.

### **UNIT III:**

#### **MANUFACTURING CONCEPTS AND ANALYSIS**

Manufacturing competitiveness - Checking the design process - conceptual design mechanism – Qualitative, physical approach - An intelligent design for manufacturing system –

### **UNIT IV:**

JIT system - low inventory - modular - Modeling and reasoning for computer based assembly planning - Design of Automated manufacturing.

#### **PROJECT MANAGEMENT**

Life Cycle semi realization - design for economics - evaluation of design for manufacturing cost

### **UNIT V**

Concurrent mechanical design - decomposition in concurrent design - negotiation in concurrent engineering design studies - product realization taxonomy - plan for Project Management on new product development – bottleneck technology development.

### **TEXT BOOKS:**

1. Integrated Product Development / Anderson MM and Hein, L. Berlin, Springer, 1987.
2. Concurrent Engineering: Automation Tools and Technology / Andrew Kusaik, John Wiley.

### **REFERENCES:**

1. Design for Concurrent Engineering / Cleetus, J, Concurrent Engg. Research Centre, Morgantown, WV, 1992.
2. Concurrent Engineering Fundamentals: Integrated Product Development/ Prasad, Prentice Hall, 1996.
3. Successful Implementation of Concurrent Product and Process / Sammy G Sinha, Wiley, John and Sons Inc., 1998.

# **DESIGN AND MANUFACTURING OF MEMS AND MICROSYSTEMS**

## **(ELECTIVE - III)**

### **UNIT I:**

#### **OVERVIEW AND WORKING PRINCIPLES OF MEMS AND MICROSYSTEMS**

MEMS & Microsystems, Evolution of Micro fabrication, Microsystems & Microelectronics, Microsystems & Miniaturization, Applications of MEMS in Industries, Micro sensors, Micro actuation, MEMS with Micro actuators Micro accelerometers, Micro fluidics.

### **UNIT II:**

#### **ENGINEERING SCIENCE FOR MICROSYSTEMS DESIGN AND FABRICATION:**

Atomic structure of Matter, Ions and Ionization, Molecular Theory of Matter and Intermolecular Force, Doping of Semiconductors, The diffusion Process, Plasma Physics, Electrochemistry, Quantum Physics

### **UNIT III:**

#### **ENGINEERING MECHANICS FOR MICROSYSTEMS DESIGN:**

Static Bending of thin Plates, Mechanical Vibration, Thermo mechanics Fracture Mechanics, Thin-Film Mechanics, Overview of Finite Element Stress Analysis

### **UNIT IV:**

#### **THERMO FLUID ENGINEERING & MICROSYSTEMS DESIGN:**

Overview of Basics of Fluid Mechanics in Macro and Meso scales, Basic equations in Continuum Fluid dynamics, Laminar Fluid Flow in Circular Conduits, Computational Fluid Dynamics, Incompressible Fluid Flow in Micro conduits, Fluid Flow in Sub micrometer and Nano scale, Overview of Heat conduction in Solids, Heat Conduction in Multilayered Thin films and in solids in sub micrometer scale, Design Considerations, Process Design Mechanical Design, Mechanical Design using FEM, Design of a Silicon Die for a Micro pressure Sensor.

### **UNIT V:**

#### **MATERIALS FOR MEMS & MICROSYSTEMS AND THEIR FABRICATION:**

Substrates and Wafers, Active substrate materials, Silicon as a substrate material, Silicon Compounds, Silicon Piezoresistors, Gallium Arsenide, Quartz, Piezoelectric Crystals and Polymers, Photolithography, Ion implantation, Diffusion and oxidation, chemical and physical vapor deposition, Etching, Bulk micro manufacturing, Surface Micromachining, The LIGA Process

### **TEXT BOOKS:**

1. MEMs & Microsystems: Design & Manufacture/ Tai-Ran Hsu/Tata Mc-Graw Hill., ed./2002
2. An Introduction to Micro electro mechanical Systems Engineering/ Maluf, M./ Artech House, Boston, 2000

### **REFERENCES:**

- 1 Micro robots and Micromechanical Systems/ Trimmer, W.S.N/ Sensors & Actuators, vol19, no.1989.
- 2 Applied Partial Differential Equations/ Trim, D.W/ PWS-Kent Publishing/ Boston 1990.
- 3 Fundamentals of Microfabrication.Madou, M/ CRC Press, Boca Raton, 1997.
- 4 The Finite Element Method in Thermomechanics/ Hsu, T.R / Alien & Unwin, London.

<b>I Year II Semester</b>		<b>L</b>	<b>P</b>	<b>C</b>
		<b>4</b>	<b>0</b>	<b>3</b>

**MECHANICS AND MANUFACTURING METHODS OF COMPOSITES  
(ELECTIVE - IV)**

**UNIT-I**

Introduction to Composites: Introduction, Classification, matrix materials, reinforced matrix of composites

**UNIT-II**

Hooke's Law for a Two-Dimensional Angle Lamina, Engineering Constants of an Angle Lamina, Invariant Form of Stiffness and Compliance Matrices for an Angle Lamina Strength Failure Theories of an Angle Lamina : Maximum Stress Failure Theory Strength Ratio, Failure Envelopes, Maximum Strain Failure Theory, Tsai-Hill Failure Theory, Tsai-Wu Failure Theory, Comparison of Experimental Results with Failure Theories. Hygrothermal Stresses and Strains in a Lamina: Hygrothermal Stress-Strain Relationships for a Unidirectional Lamina, Hygrothermal Stress-Strain Relationships for an Angle Lamina

**UNIT-III**

Macromechanical Analysis of a Lamina :Introduction ,Definitions: Stress, Strain ,Elastic Moduli,Strain Energy. Hooke's Law for Different Types of Materials, Hooke's Law for a Two-Dimensional Unidirectional Lamina, Plane Stress Assumption, Reduction of Hooke's Law in Three Dimensions to Two Dimensions, Relationship of Compliance and Stiffness Matrix to Engineering Elastic Constants of a Lamina,

**UNIT-IV**

Micromechanical Analysis of a Lamina :Introduction, Volume and Mass Fractions, Density, and Void Content, Evaluation of the Four Elastic Moduli, Strength of Materials Approach, Semi-Empirical Models ,Elasticity Approach, Elastic Moduli of Lamina with Transversely Isotropic Fibers, Ultimate Strengths of a Unidirectional Lamina, Coefficients of Thermal Expansion, Coefficients of Moisture Expansion

Macromechanical Analysis of Laminates: Introduction , Laminate Code , Stress-Strain Relations for a Laminate, In-Plane and Flexural Modulus of a Laminate , Hygrothermal Effects in a Laminate, Warp of Laminates, hybrid laminates

**UNIT-V**

Design of Laminates : Introduction , thin plate theory, specially orthotropic plate, cross and angle ply laminated plates, problems using thin plate theory, Failure Criterion for a Laminate, Design of a Laminated Composites.

**TEXT BOOKS:**

- 1.Engineering Mechanics of Composite Materials by Isaac and M Daniel, Oxford University Press, 1994.
- 2.B. D. Agarwal and L. J. Broutman, Analysis and performance of fibre Composites,Wiley-Interscience, New York, 1980.
3. Mechanics of Composite Materials, Second Edition (Mechanical Engineering), By Autar K. Kaw ,Publisher: CRC

**REFERENCES:**

1. R. M. Jones, Mechanics of Composite Materials, Mc Graw Hill Company, New York, 1975.

2. L. R. Calcote, Analysis of Laminated Composite Structures, Van Nostrand Reinhold, New York, 1969.
3. L. R. Calcote, Analysis of Laminated Composite Structures, Van Nostrand Reinhold, New York, 1969.

## **MATERIALS TECHNOLOGY**

### **(ELECTIVE - IV)**

#### **UNIT I:**

Elasticity in metals, mechanism of plastic deformation, slip and twinning, role of dislocations, yield stress, shear strength of perfect and real crystals, strengthening mechanism, work hardening, solid solution, grain boundary strengthening. Poly phase mixture, precipitation, particle, fiber and dispersion strengthening, effect of temperature, strain and strain rate on plastic behavior, super plasticity, Yield criteria: Von-mises and Tresca criteria.

#### **UNIT II:**

Griffith's Theory, stress intensity factor and fracture Toughness, Toughening Mechanisms, Ductile and Brittle transition in steel, High Temperature Fracture, Creep, Larson – Miller parameter, Deformation and Fracture mechanism maps.

#### **UNIT III:**

Fatigue, fatigue limit, features of fatigue fracture, Low and High cycle fatigue test, Crack Initiation and Propagation mechanism and Paris Law, Effect of surface and metallurgical parameters on Fatigue, Fracture of non-metallic materials, fatigue analysis, Sources of failure, procedure of failure analysis. Motivation for selection, cost basis and service requirements, Selection for Mechanical Properties, Strength, Toughness, Fatigue and Creep.

#### **UNIT IV:**

Modern Metallic Materials: Dual Steels, Micro alloyed, High Strength Low alloy (HSLA) Steel, Transformation induced plasticity (TRIP) Steel, Maraging Steel, Inter metalics, Ni and Ti Aluminides. Processing and applications of Smart Materials, Shape Memory alloys, Metallic Glass Quasi Crystal and Nano Crystalline Materials.

#### **UNIT V:**

Nonmetallic Materials: Polymeric materials and their molecular structures, Production Techniques for Fibers, Foams, Adhesives and Coatings, structure, Properties and Applications of Engineering Polymers, Advanced Structural Ceramics WC, TiC, TaC,  $Al_2O_3$ , SiC,  $Si_3N_4$ , CBN and Diamond – properties, Processing and applications.

#### **TEXT BOOKS:**

1. Mechanical Behavior of Materials/Thomas H. Courtney/ McGraw Hill/2 nd Edition/2000
2. Mechanical Metallurgy/George E. Dieter/McGraw Hill, 1998.

#### **REFERENCES:**

- 1 Selection and use of Engineering Materials 3e/Charles J.A/Butterworth Heiremann.
- 2 Engineering Materials Technology/James A Jacob Thomas F Kilduff/Pearson
- 3 Material Science and Engineering/William D Callister/John Wiley and Sons
- 4 Plasticity and plastic deformation by Arizur.
- 5 Introduction to Ceramics, 2nd Edition by W. David Kingery, H. K. Bowen, Donald R. Uhlmann

## **INTELLIGENT MANUFACTURING SYSTEMS (ELECTIVE - IV)**

### **UNIT I:**

**COMPUTER INTEGRATED MANUFACTURING SYSTEMS:** structure and functional areas of cim system- CAD, CAPP, CAM, CAQC, ASRS. Advantages of CIM. Manufacturing Communication Systems - MAP/TOP, OSI Model, Data Redundancy, Top- down and Bottom-up Approach, Volume of Information. Intelligent Manufacturing System Components, System Architecture and Data Flow, System Operation.

### **UNIT II:**

**COMPONENTS OF KNOWLEDGE BASED SYSTEMS** - Basic Components of Knowledge Based Systems, Knowledge Representation, Comparison of Knowledge Representation Schemes, Inference Engine, Knowledge Acquisition.

### **UNIT III:**

**MACHINE LEARNING** - Concept of Artificial Intelligence, Conceptual Learning, Artificial Neural Networks - Biological Neuron, Artificial Neuron, Types of Neural Networks, Applications in Manufacturing.

### **UNIT IV:**

**AUTOMATED PROCESS PLANNING** - Variant Approach, Generative Approach, Expert Systems for Process Planning, Feature Recognition, Phases of Process planning. Knowledge Based System for Equipment Selection (KBSES) - Manufacturing system design. Equipment Selection Problem, Modeling the Manufacturing Equipment Selection Problem, Problem Solving approach in KBSES, Structure of the KRSES.

### **UNIT V:**

**GROUP TECHNOLOGY:** Models and Algorithms Visual Method, Coding Method, Cluster Analysis Method, Matrix Formation - Similarity Coefficient Method, Sorting-based Algorithms, Bond Energy Algorithm, Cost Based method, Cluster Identification Method, Extended CI Method. Knowledge Based Group Technology - Group Technology in Automated Manufacturing System. Structure of Knowledge based system for group technology (KBSCIT) — Data Base, Knowledge Base, Clustering Algorithm.

### **TEXT BOOKS:**

1. Intelligent Manufacturing Systems/ Andrew Kusiak/Prentice Hall.
2. Artificial Neural Networks/ Yagna Narayana/PHI/2006
3. Automation, Production Systems and CIM / Groover M.P./PHI/2007

## **SIGNAL ANALYSIS AND CONDITION MONITORING (ELECTIVE - IV)**

### **UNIT-I**

Introduction, Basic concepts. Fourier analysis. Bandwidth. Signal types. Convolution.

**Signal analysis:** Filter response time. Detectors. Recorders. Analog analyzer types.

### **UNIT-II**

**PRACTICAL ANALYSIS OF STATIONARY SIGNALS:** Stepped filter analysis. Swept filter analysis. High speed analysis. Real-time analysis.

### **UNIT-III**

**PRACTICAL ANALYSIS OF CONTINUOUS NON-STATIONARY SIGNALS:** Choice of window type. Choice of window length. Choice of incremental step. Practical details. Scaling of the results.

### **UNIT-IV**

**PRACTICAL ANALYSIS OF TRANSIENTS:** Analysis as a periodic signal. Analysis by repeated playback (constant bandwidth). Analysis by repeated playback (variable bandwidth).

### **UNIT-V**

**CONDITION MONITORING IN REAL SYSTEMS:** Diagnostic tools. Condition monitoring of two stage compressor. Cement mill foundation. I.D. fan. Sugar centrifugal. Cooling tower fan. Air separator. Preheater fan. Field balancing of rotors. ISO standards on vibrations, active, passive hybrid methods of condition monitoring

### **TEST BOOK:**

1. Condition Monitoring of Mechanical Systems / Kolacat.

### **REFERENCES:**

1. Frequency Analysis /R.B.Randall.
2. Mechanical Vibrations Practice with Basic Theory / V. Ramamurti/ Narosa Publishing House.
3. Theory of Machines and Mechanisms/ Amitabh Ghosh & AK Malik/ EWP

<b>I Year II Semester</b>	<b>MODELING AND ANALYSIS OF MANUFACTURING PROCESSES LABORATORY</b>	<b>L</b>	<b>P</b>	<b>C</b>
		<b>0</b>	<b>3</b>	<b>2</b>

**Students shall carry out the modeling and FE analysis of at least three processes of each category given below.**

1. Casting processes - Simulation of Solidification, temperatures, Residual stresses, metallurgical phases etc.
2. Forging processes - Simulation of cold working and hot working processes for extrusion, drawing, rolling, etc.
3. Forming Processes – Simulation of blanking, bending, deep drawing, etc.
4. Welding Processes – Simulation of arc, spot, laser welding, etc